



ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)					
PARAMETER	TEST CONDITION	PART	SYMBOL	VALUE	UNIT
INPUT					
Reverse voltage			V_R	6	V
Forward current			I_F	60	mA
Surge current			I_{FSM}	2.5	A
Power dissipation			P_{diss}	100	mW
Derate from 25 °C				1.33	mW/°C
OUTPUT					
Peak off-state voltage		IL420	V_{DRM}	600	V
		IL4208	V_{DRM}	800	V
RMS on-state current			I_{TM}	300	mA
Single cycle surge current			I_{TSM}	3	A
Power dissipation			P_{diss}	500	mW
Derate from 25 °C				6.6	mW/°C
COUPLER					
Isolation test voltage between emitter and detector	$t = 1\text{ s}$		V_{ISO}	5300	V_{RMS}
Isolation resistance	$V_{IO} = 500\text{ V}, T_{amb} = 25\text{ }^{\circ}\text{C}$		R_{IO}	$\geq 10^{12}$	Ω
	$V_{IO} = 500\text{ V}, T_{amb} = 100\text{ }^{\circ}\text{C}$		R_{IO}	$\geq 10^{11}$	Ω
Storage temperature range			T_{stg}	- 55 to + 150	°C
Ambient temperature range			T_{amb}	- 55 to + 100	°C
Soldering temperature ⁽¹⁾	max. $\leq 10\text{ s}$ dip soldering $\geq 0.5\text{ mm}$ from case bottom		T_{sld}	260	°C

Notes

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.
- (1) Refer to reflow profile for soldering conditions for surface mounted devices (SMD). Refer to wave profile for soldering conditions for through hole devices (DIP).

ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT						
Forward voltage	$I_F = 10\text{ mA}$	V_F		1.16	1.35	V
Reverse current	$V_R = 6\text{ V}$	I_R		0.1	10	μA
Input capacitance	$V_F = 0\text{ V}, f = 1\text{ MHz}$	C_{IN}		40		pF
Thermal resistance, junction to ambient		R_{thja}		750		°C/W
OUTPUT						
Off-state current	$V_D = V_{DRM}, T_{amb} = 100\text{ }^{\circ}\text{C}$	I_{DRM}		10	100	μA
On-state voltage	$I_T = 300\text{ mA}$	V_{TM}		1.7	3	V
Surge (non-repetitive), on-state current	$f = 50\text{ Hz}$	I_{TSM}			3	A
Holding current		I_H		65	500	μA
Latching current	$V_T = 2.2\text{ V}$	I_L			500	μA
LED trigger current	$V_D = 5\text{ V}$	I_{FT}		1	2	mA
Trigger current temperature gradient		$\Delta I_{FT}/\Delta T_j$		7	14	$\mu\text{A}/^{\circ}\text{C}$
Critical rate of rise off-state voltage	$V_D = 0.67 V_{DRM}, T_j = 25\text{ }^{\circ}\text{C}$	dV/dt_{cr}	10 000			V/ μs
	$V_D = 0.67 V_{DRM}, T_j = 80\text{ }^{\circ}\text{C}$	dV/dt_{cr}	5000			V/ μs
Critical rate of rise of voltage at current commutation	$V_D = 230 V_{RMS}, I_D = 300\text{ mA}_{RMS}, T_j = 25\text{ }^{\circ}\text{C}$	dV/dt_{crq}		8		V/ μs
	$V_D = 230 V_{RMS}, I_D = 300\text{ mA}_{RMS}, T_j = 85\text{ }^{\circ}\text{C}$	dV/dt_{crq}		7		V/ μs
Critical rate of rise of on-state current commutation		dI/dt_{crq}		12		A/ms
Thermal resistance, junction to ambient		R_{thja}		150		°C/W

ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
COUPLER						
Critical rate of rise of coupled input/output voltage	$I_T = 0\text{ A}$, $V_{RM} = V_{DM} = V_{DRM}$	dV/dt		5000		V/ μs
Capacitance (input to output)	$f = 1\text{ MHz}$, $V_{IO} = 0\text{ V}$	C_{IO}		0.8		pF

Note

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements.

SWITCHING CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Turn-on time	$V_{RM} = V_{DM} = V_{DRM}$	t_{on}		35		μs

SAFETY AND INSULATION RATINGS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Climatic classification (according to IEC68 part 1)				55/100/21		
Comparative tracking index		CTI	175		399	
V_{IOTM}			8000			V
V_{IORM}			630			V
P_{SO}					500	mW
I_{SI}					250	mA
T_{SI}					175	$^{\circ}\text{C}$
Creepage distance	Standard DIP-8		7			mm
Clearance distance	Standard DIP-8		7			mm
Creepage distance	400 mil DIP-8		8			mm
Clearance distance	400 mil DIP-8		8			mm
Insulation thickness	For IL4208 only		0.4			mm

Note

- As per IEC60747-5-2, § 7.4.3.8.1, this optocoupler is suitable for “safe electrical insulation” only within the safety ratings. Compliance with the safety ratings shall be ensured by means of protective circuits.

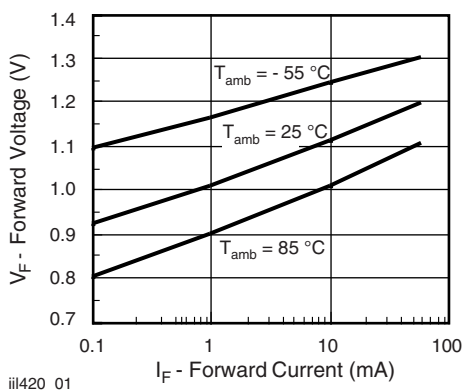
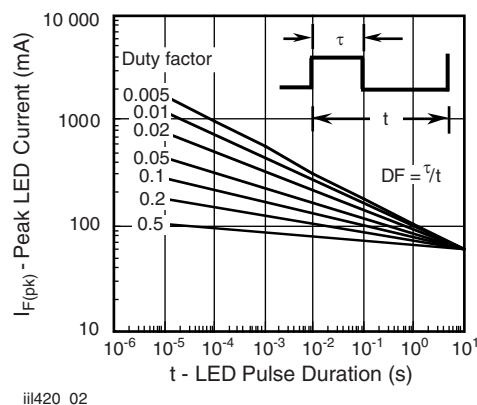
TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)


Fig. 1 - Forward Voltage vs. Forward Current


Fig. 2 - Peak LED Current vs. Duty Factor, τ

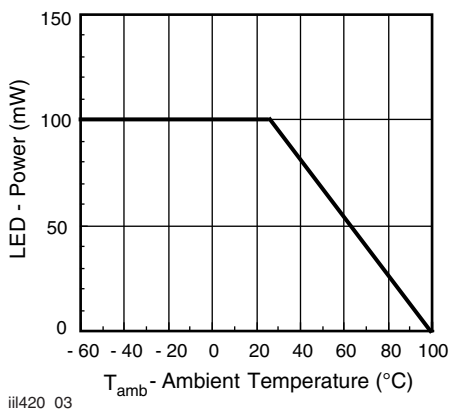


Fig. 3 - Maximum LED Power Dissipation

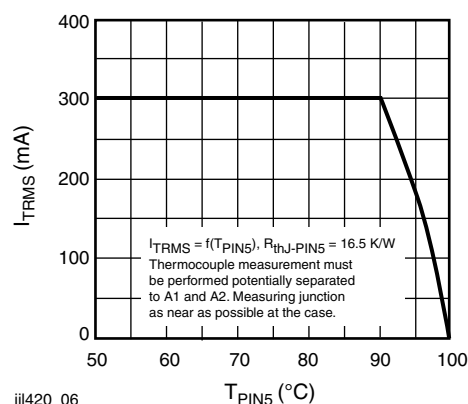


Fig. 6 - Current Reduction

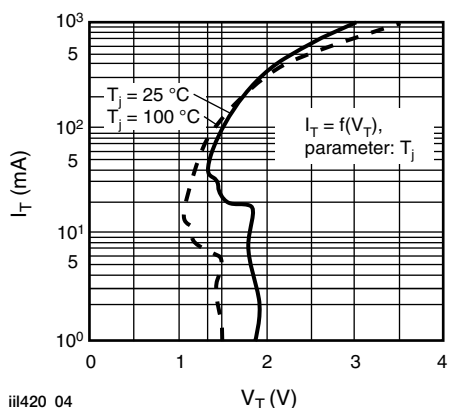


Fig. 4 - Typical Output Characteristics

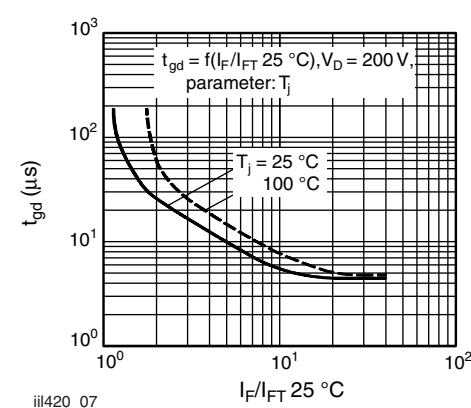


Fig. 7 - Typical Trigger Delay Time

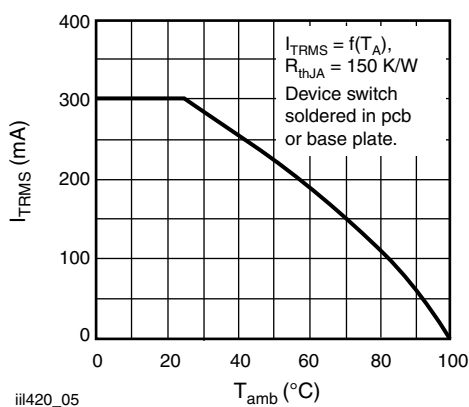


Fig. 5 - Current Reduction

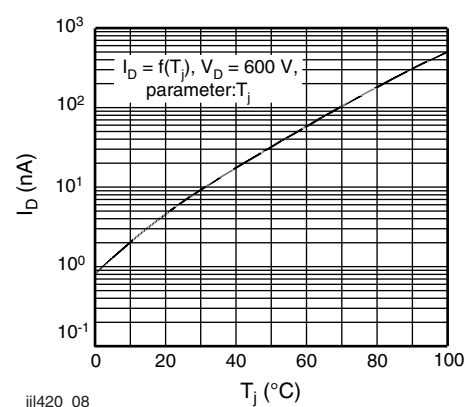


Fig. 8 - Typical Off-State Current

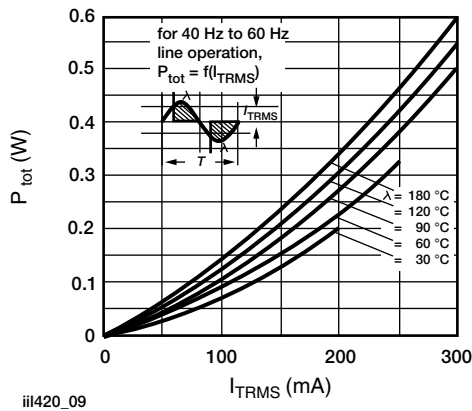


Fig. 9 - Power Dissipation

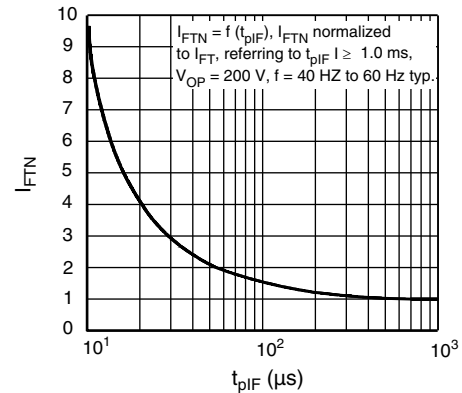
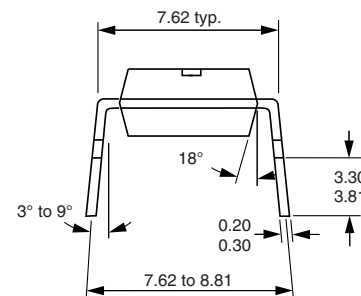
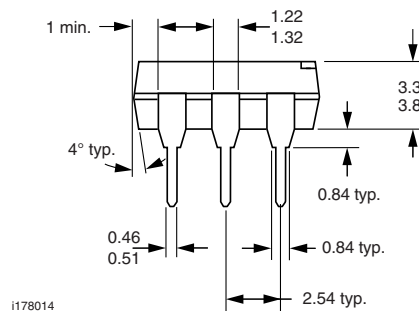
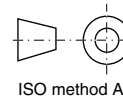
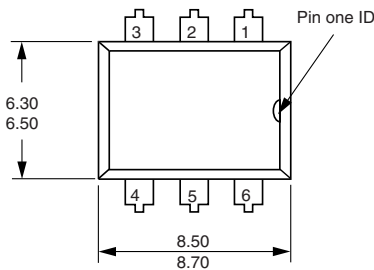
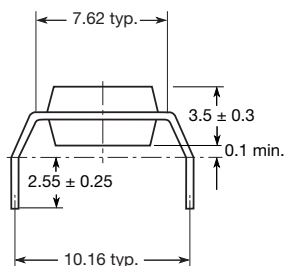
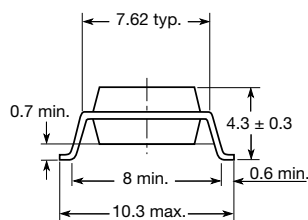
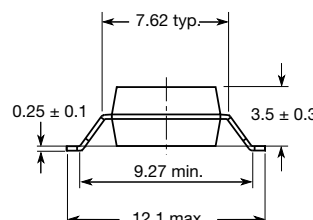
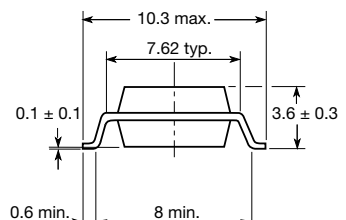
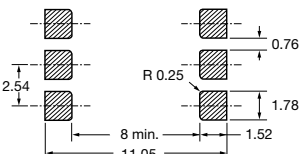
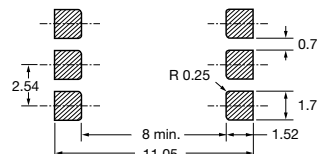
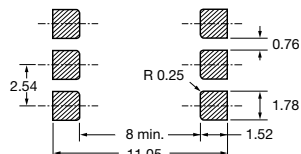


Fig. 10 - Pulse Trigger Current

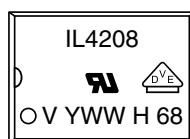
PACKAGE DIMENSIONS in millimeters

Option 6

Option 7

Option 8

Option 9


20802-25





PACKAGE MARKING (example)



Notes

- Only options 1, 7, and 8 are reflected in the package marking.
- The VDE Logo is only marked on option 1 parts.
- Tape and reel suffix (T) is not part of the package marking.



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